

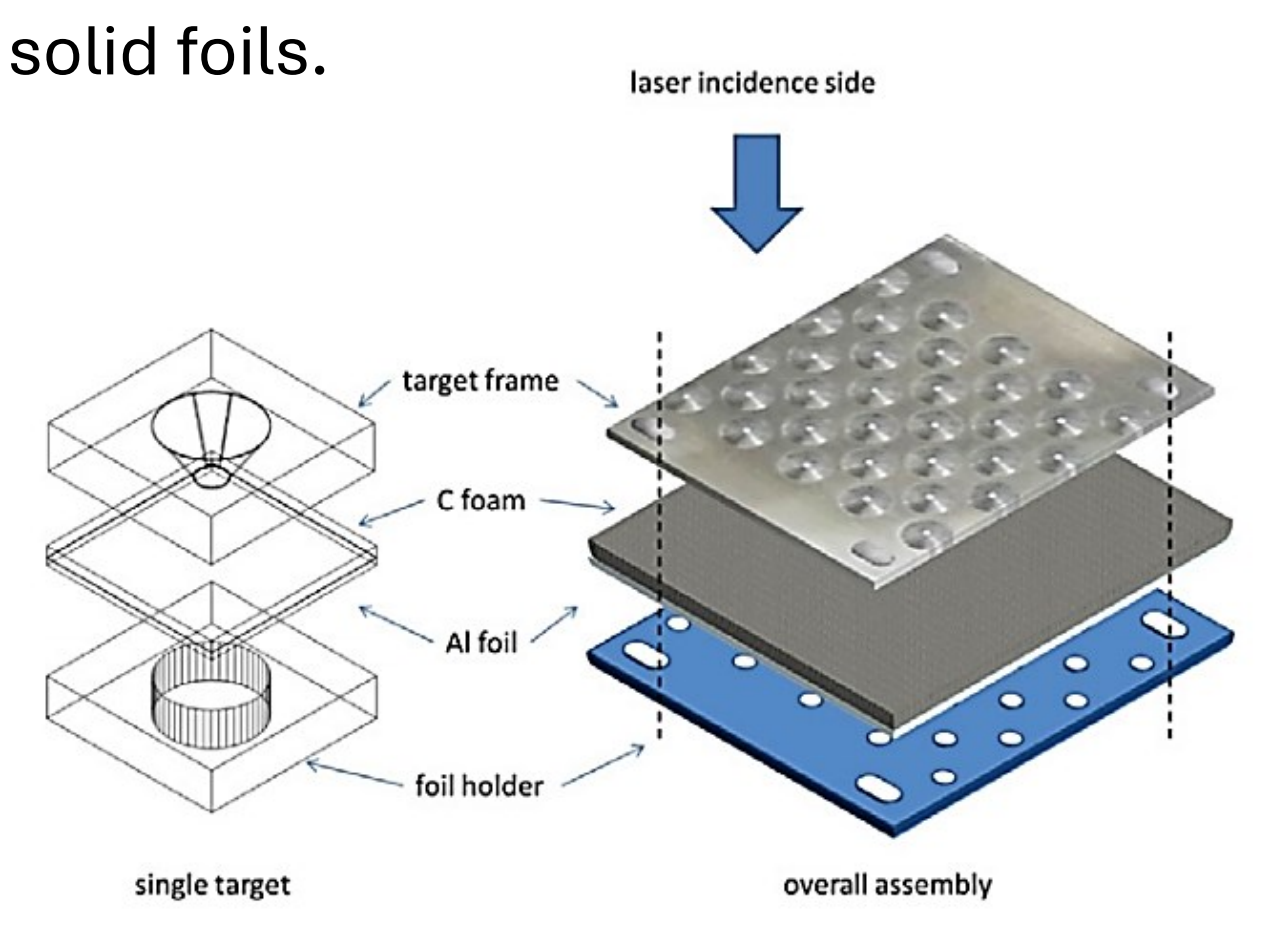


Near-critical double-layer target (DLT)

- Solid foil covered by a near-critical density layer.
- Enhanced laser-plasma coupling through the near-critical layer.
- Hotter relativistic electrons.
- More ions at higher energies.

Standard DLT production

- Deposition of near-critical layer on commercially available solid foils.
- Foam-based DLT successfully exploited in laser-driven experiments [1,2,3].
- Limitations: thickness uncertainty, limited thickness and material available, deformation while handling and attaching to the holder.

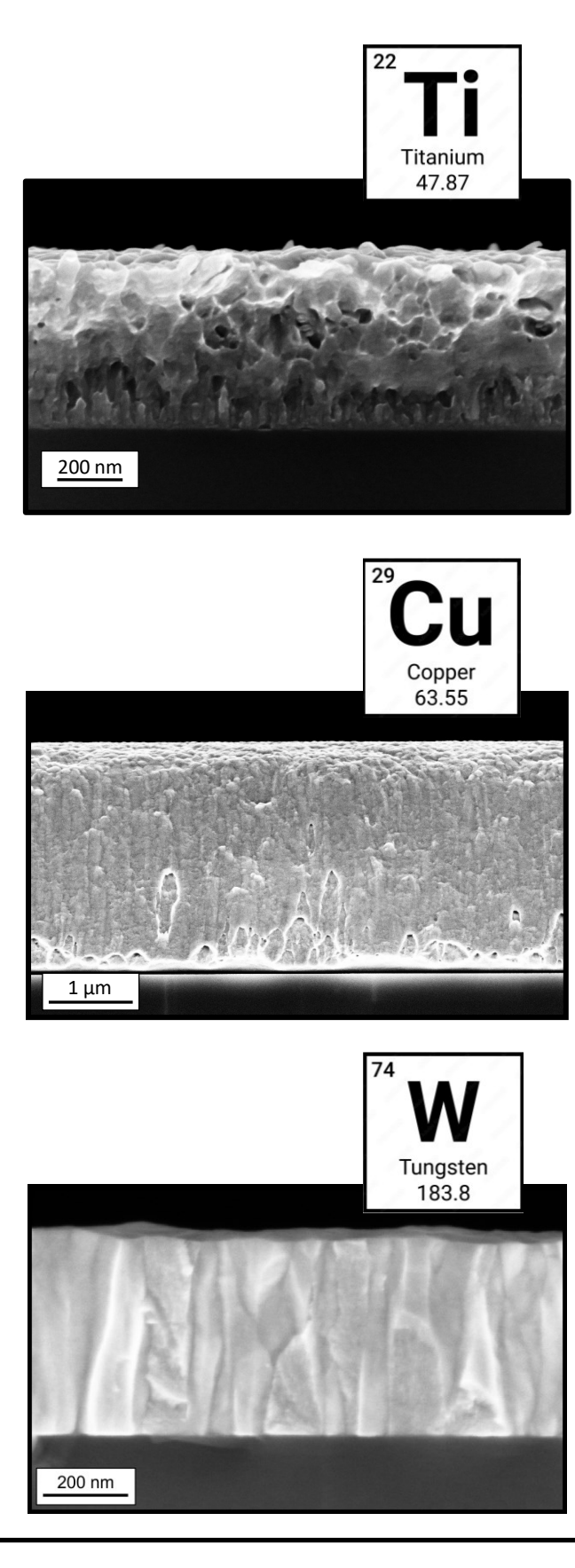
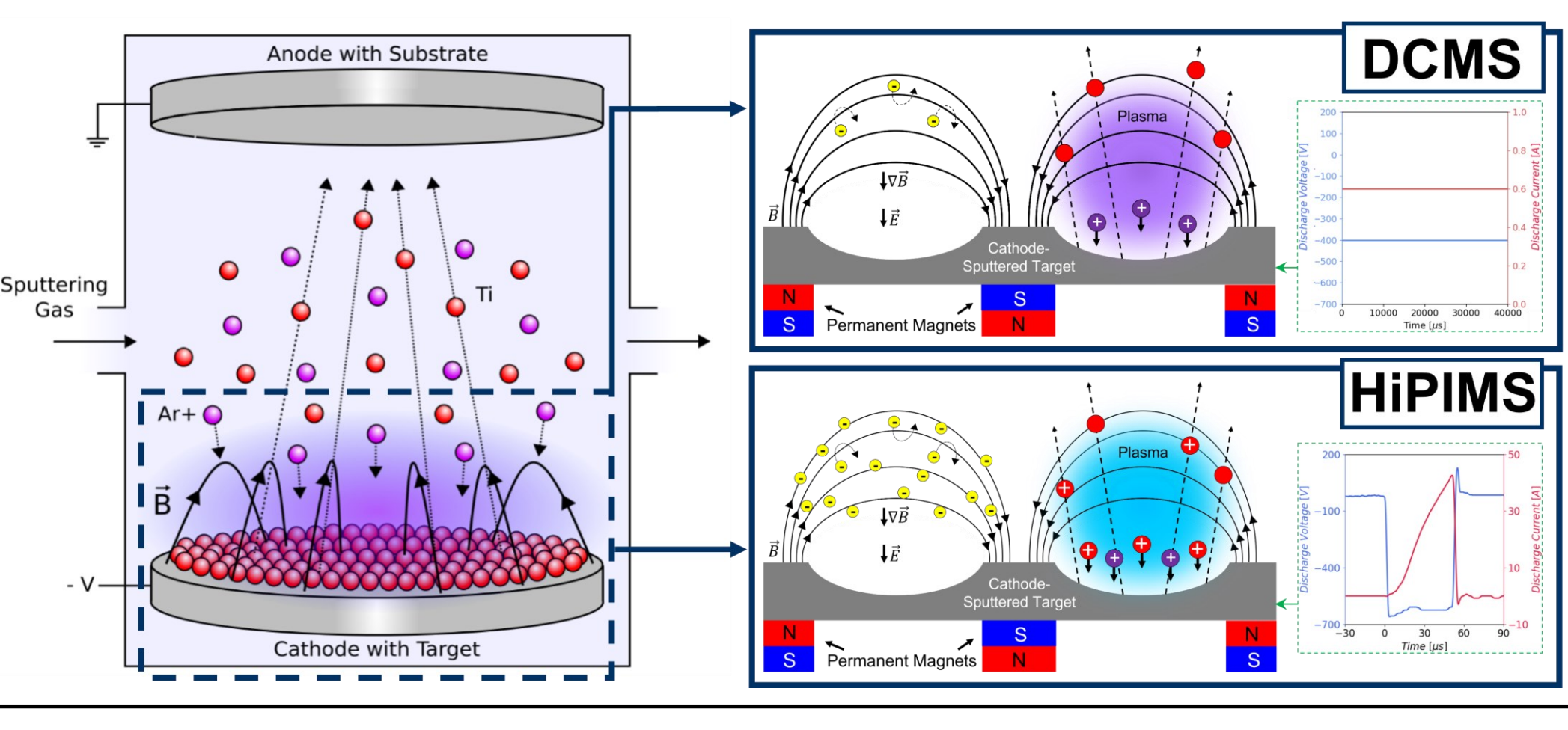


Direct deposition of target on the holder by Physical Vapor Deposition (PVD) techniques!

Experimental Methods: PVD techniques

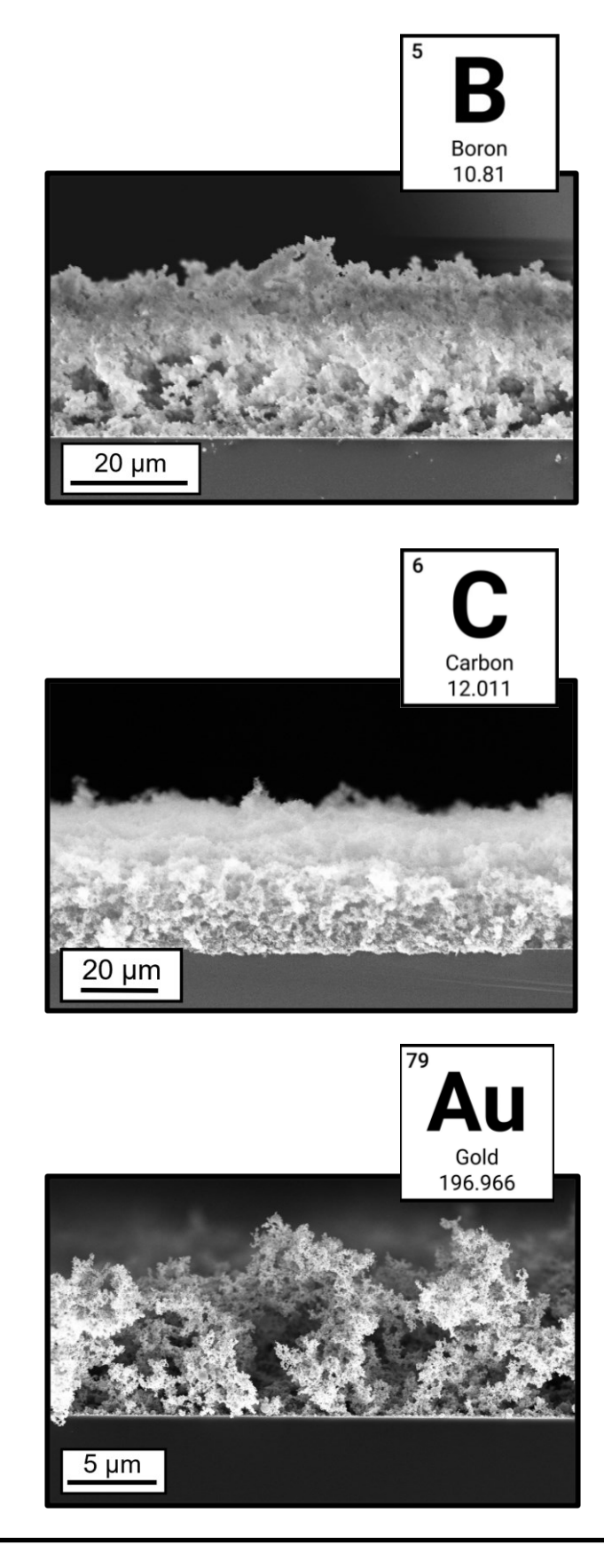
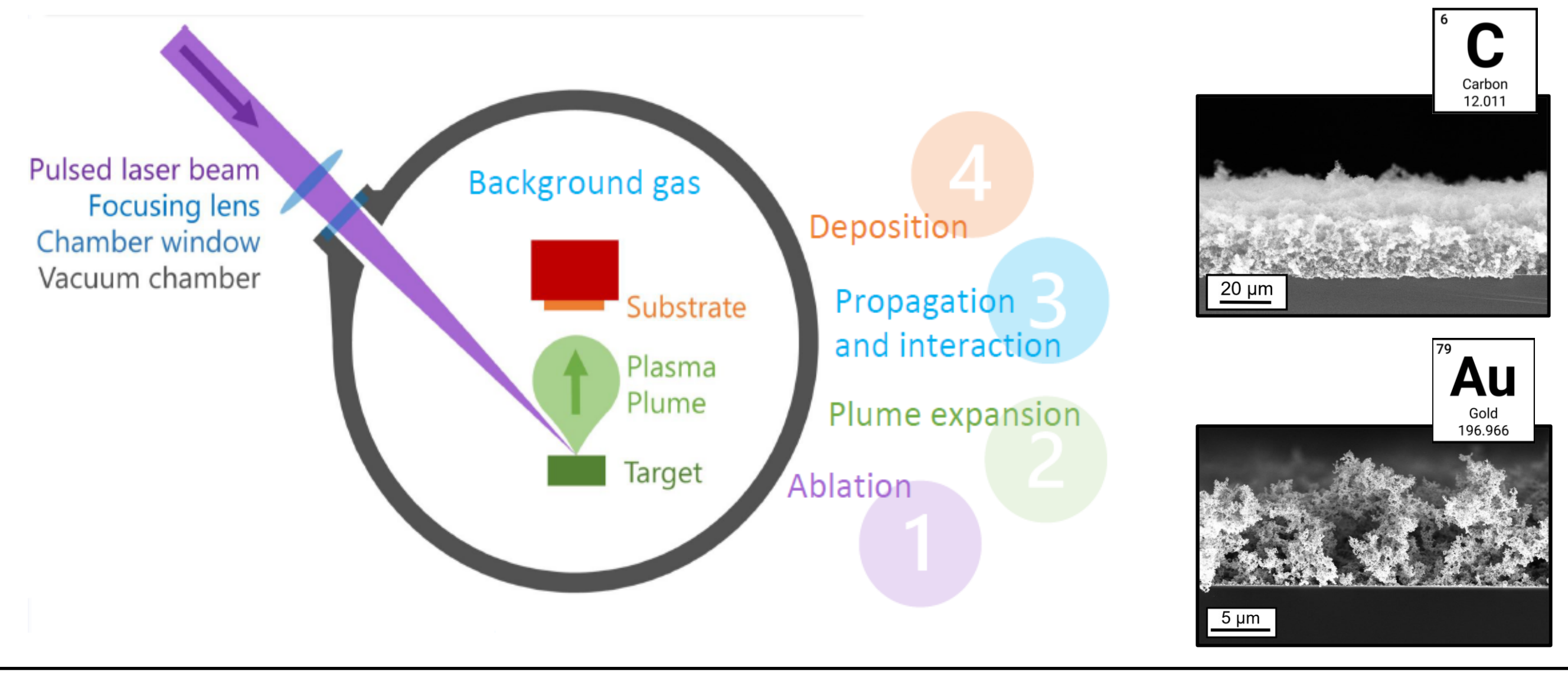
Magnetron Sputtering (MS)

- Ejection of atoms from a target caused by energetic ions of an inert gas. Electrons are trapped by a properly shaped magnetic field.
- Direct Current Magnetron Sputtering (DCMS): a constant voltage is applied to sputter.
- High Power Impulse Magnetron Sputtering (HiPIMS) [4]:
 - pulses with high peak power
 - pulse length 50 – 400 μ s
 - low repetition frequency (50 – 5000 Hz)
 - low duty cycle (< 10 %)
- \uparrow density plasma, \uparrow ionization degree, \uparrow sputtered species energy.
 - Improvement of film properties.
 - Deposition on complex substrates.



Pulsed Laser Deposition (PLD)

- Ablation of material from a solid target by laser pulses.
- ns-PLD**
 - well established.
 - few ns pulses.
 - 100s mJ per pulse.
 - Up to 10 Hz.
- fs-PLD**
 - non-standard technique [5].
 - <100 fs pulses.
 - few mJ per pulse.
 - kHz or higher.
 - Nanostructured low-density film of any element.



Strategy for Freestanding DLT Production

Holder preparation

1

- Holder holes filled with a sacrificial material to be removed after the solid-density layer deposition.
- Caramel: soluble in water, amorphous material, planar uniform surface, compatible with PVD subsequent depositions.

Removal of the filling material

- Caramel dissolution in water (few minutes).
- Titanium freestanding films.

Titanium film deposition

2

- Deposition of hybrid DCMS/HiPIMS titanium films [6]:
 - 4 hybrid layers (80% DCMS, 20% HiPIMS)
 - Application of substrate bias voltage.
- 200 nm \div 2 μ m thickness range.
- Near-bulk film density (80% or greater).
- Low residual stress state.

Near-critical carbon foam deposition

4

- fs-PLD carbon foam deposition [7]:
 - High Argon pressure (250 Pa)
 - Void-rich fractal structure.
 - Thickness \approx 10s μ m.
 - Density \approx 6 mg/cm³.
- Good adhesion on freestanding titanium films with thickness equal or greater than 400 nm.
- Low material deposition on the 200 nm-thick freestanding films.
- Freestanding films vibrations during PLD deposition.

Conclusions & Foreseen Activities

- Effective production of near-critical DLT directly on target holders.
- Compatibility between layers grown by HiPIMS/DCMS and fs-PLD.
- Exploration of different combinations of materials for solid and near-critical layers.
- Experimental test in particle acceleration campaigns.

References

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